



GLASS PASSIVATED RECTIFIERS

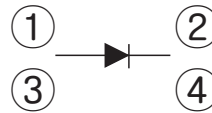
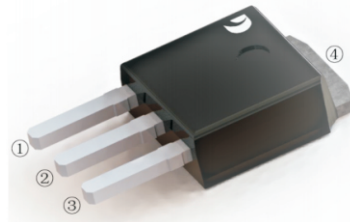
Reverse Voltage - 100 to 1000 V

Forward Current - 4.0 A

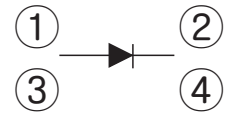
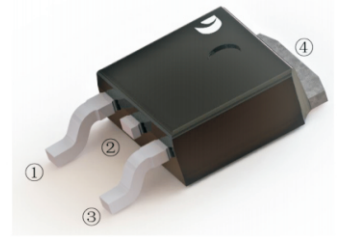
FEATURES

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any

TO-251(I-PAK)



TO-252(D-PAK)



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	TO-251	G401VY	G402VY	G404VY	G406VY	G408VY	G410VY	Units
	TO-252	G401DY	G402DY	G404DY	G406DY	G408DY	G410DY	
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	4.0						A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	140						A
Max Instantaneous Forward Voltage at 4 A DC	V_F	1.1						V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 125^\circ\text{C}$	I_R	5 500						μA
Typical Junction Capacitance ⁽¹⁾	C_j	50						pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JC}$	50						$^\circ\text{C/W}$
Operating Junction Temperature Range	T_j	-55 ~ +150						$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-55 ~ +150						$^\circ\text{C}$

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 10cmX10cmX1mm copper pad areas.



Fig.1 Typical Forward Current Derating Curve

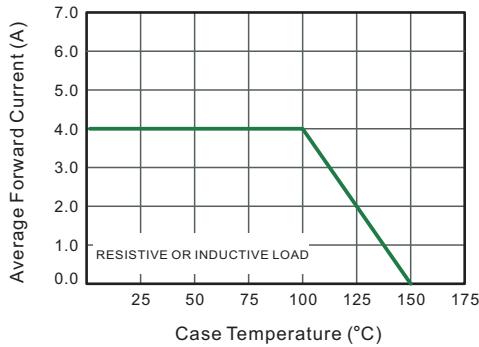


Fig.2 Typical Instantaneous Reverse Characteristics

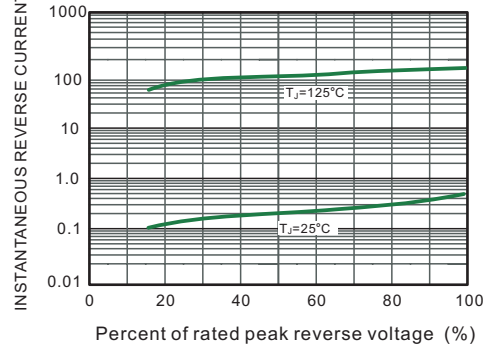


Fig.3 Typical Forward Characteristic

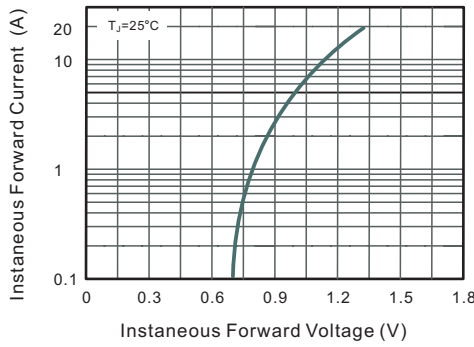


Fig.4 Typical Junction Capacitance

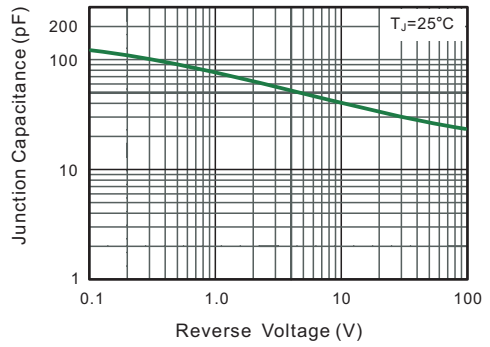


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

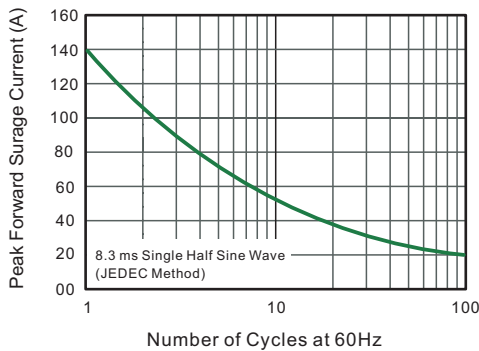
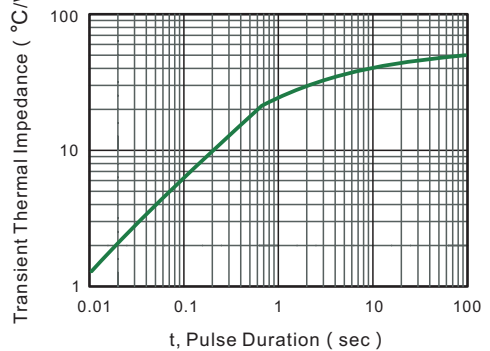
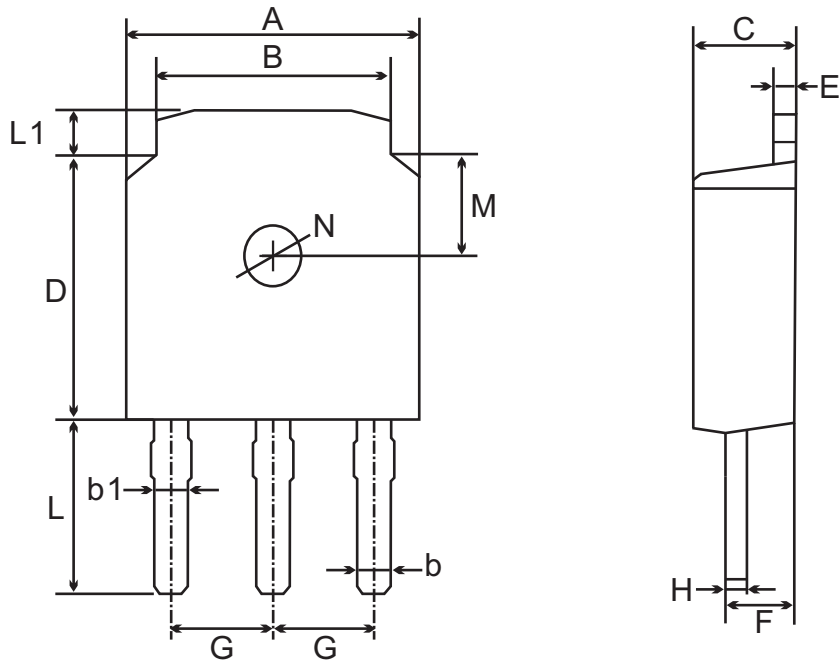


Fig.6- Typical Transient Thermal Impedance





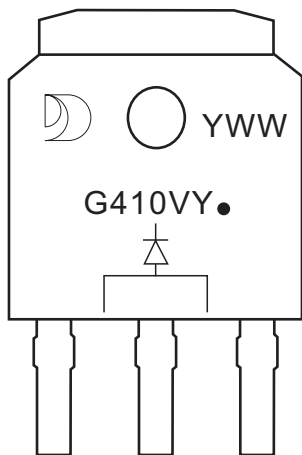
TO-251(I-PAK) Package Outline Dimensions



TO-251(I-PAK) mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	6.7	5.5	0.8	0.9	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	4.3	1.2	1.8 TYPICAL	1.3 TYPICAL
	min	6.3	5.1	0.3	0.76	2.1	5.9	0.4	1.3		0.45	3.9	0.8		
mil	max	264	217	31	35	98	248	24	71	90 TYPICAL	22	169	47	71 TYPICAL	51 TYPICAL
	min	248	201	12	30	83	232	16	51		18	154	31		

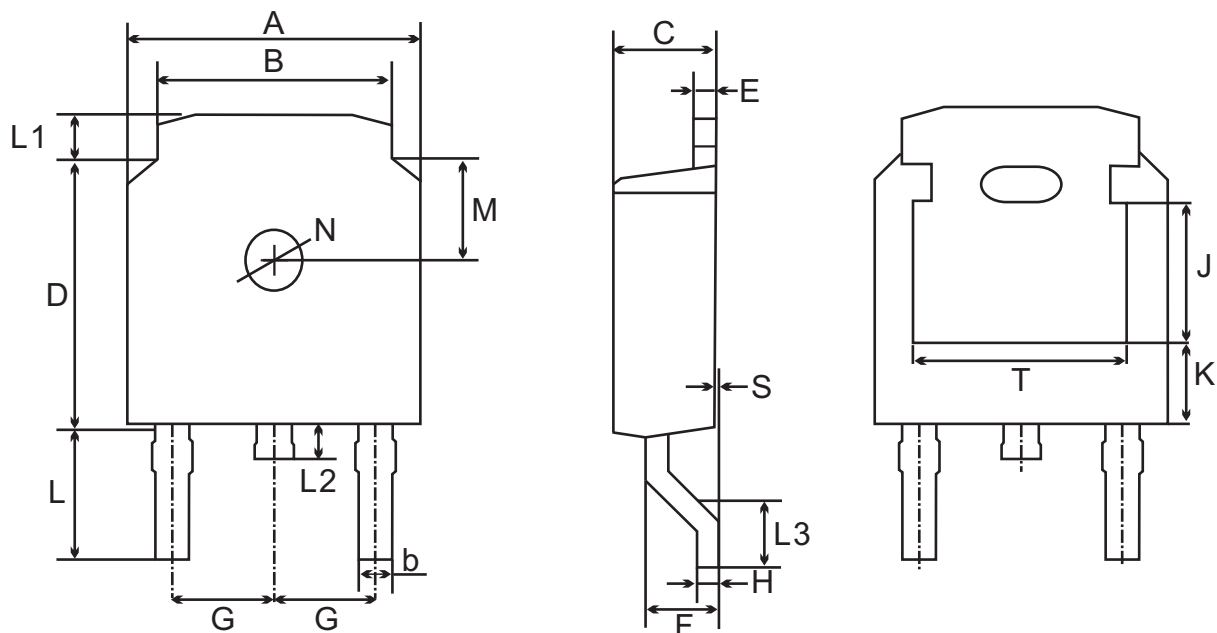
MARKING DIAGRAM



YWW: Date Code
Y: Years(0~9)
WW: Week
G410VY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



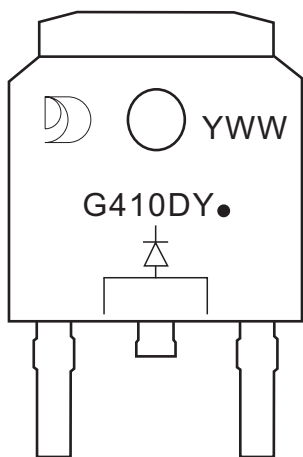
TO-252(D-PAK) Package Outline Dimensions



TO-252(D-PAK) mechanical data

UNIT	A	B	b	C	D	E	F	G	H	L	L1	L2	L3	S	M	N	J	K	T	
mm	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL	1.3 TYPICAL	3.16	1.80	4.83
	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.40	0.0			ref.	ref.	ref.
mil	max	264	217	31	98	248	24	71	90 TYPICAL	22	122	47	39	69	4	71 TYPICAL	51 TYPICAL	124	71	190
	min	248	201	12	83	232	16	51		18	106	31	24	55	0			ref.	ref.	ref.

MARKING DIAGRAM



YWW: Date Code
Y: Years(0~9)
WW: Week
G410DY: Product name
(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)



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